

In the Claims:

✓
Please cancel claim 13.

Claim ~~11~~ (amended). A component, which comprises:

a substrate;

a lower insulating layer having a layer thickness between 0.05 μm and 50 μm and having a region;

at least one upper insulating layer having a layer thickness between 0.05 μm and 50 μm and having a region;

at least one activated region that is activated for a process selected from the group consisting of subsequent metallization, photosensitization and hydrophobicization;

said at least one activated region being selected from the group consisting of said region of said lower insulating layer and said region of said at least one upper insulating layer;

said lower insulation layer located adjacent said at least one upper insulation layer; and

said lower insulating layer being chemically different from said at least one upper insulating layer.

Claim ~~14~~³ (amended). The component according to claim ~~11~~¹

wherein said at least one upper insulating layer is a layer

selected from the group consisting of a patterned layer and a

mask layer for activating said lower insulating layer.